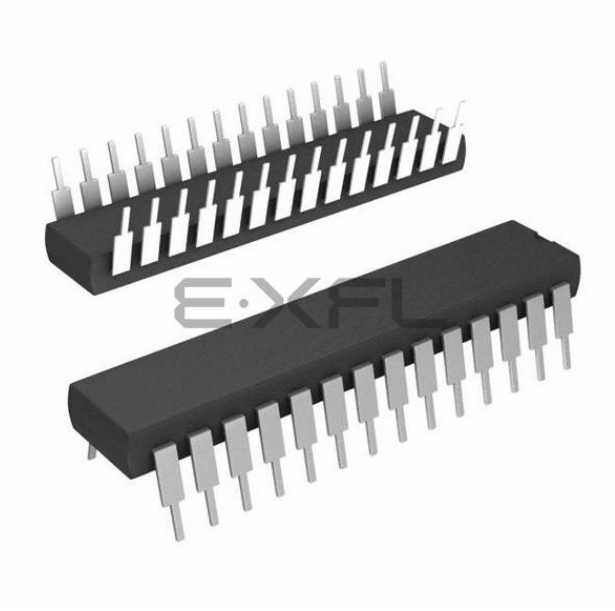

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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	64MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	25
Program Memory Size	32KB (16K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 35x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.300", 7.62mm)
Supplier Device Package	28-SPDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18lf25k40-e-sp

2.5 External Oscillator Pins

Many microcontrollers have options for at least two oscillators: a high-frequency primary oscillator and a low-frequency secondary oscillator (refer to **Section 4.0 "Oscillator Module (with Fail-Safe Clock Monitor)"** for details).

The oscillator circuit should be placed on the same side of the board as the device. Place the oscillator circuit close to the respective oscillator pins with no more than 0.5 inch (12 mm) between the circuit components and the pins. The load capacitors should be placed next to the oscillator itself, on the same side of the board.

Use a grounded copper pour around the oscillator circuit to isolate it from surrounding circuits. The grounded copper pour should be routed directly to the MCU ground. Do not run any signal traces or power traces inside the ground pour. Also, if using a two-sided board, avoid any traces on the other side of the board where the crystal is placed.

Layout suggestions are shown in Figure 2-3. In-line packages may be handled with a single-sided layout that completely encompasses the oscillator pins. With fine-pitch packages, it is not always possible to completely surround the pins and components. A suitable solution is to tie the broken guard sections to a mirrored ground layer. In all cases, the guard trace(s) must be returned to ground.

In planning the application's routing and I/O assignments, ensure that adjacent port pins, and other signals in close proximity to the oscillator, are benign (i.e., free of high frequencies, short rise and fall times, and other similar noise).

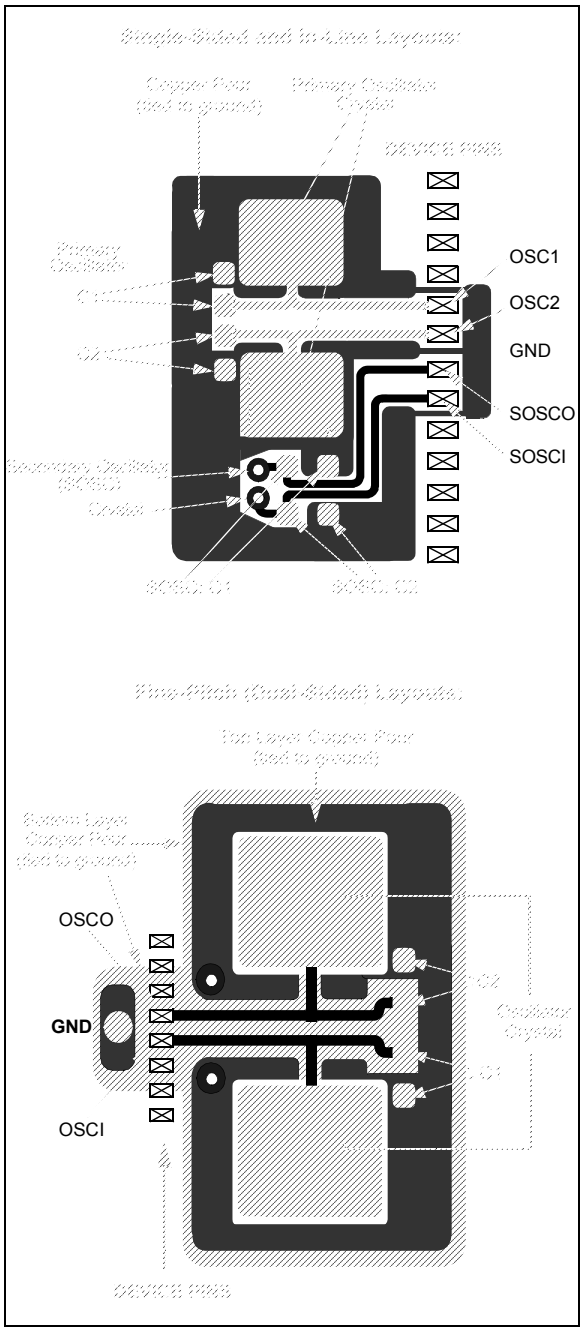
For additional information and design guidance on oscillator circuits, please refer to these Microchip Application Notes, available at the corporate website (www.microchip.com):

- *AN826,* "*Crystal Oscillator Basics and Crystal Selection for rfPIC™ and PICmicro® Devices"*
- *AN849, "Basic PICmicro® Oscillator Design"*
- *AN943, "Practical PICmicro® Oscillator Analysis and Design"*
- *AN949, "Making Your Oscillator Work"*

2.6 Unused I/Os

Unused I/O pins should be configured as outputs and driven to a logic low state. Alternatively, connect a 1 kΩ to 10 kΩ resistor to VSS on unused pins and drive the output to logic low.

FIGURE 2-3: SUGGESTED PLACEMENT OF THE OSCILLATOR CIRCUIT



4.3.2.6 Oscillator Status and Manual Enable

The Ready status of each oscillator (including the ADCRC oscillator) is displayed in OSCSTAT (Register 4-4). The oscillators (but not the PLL) may be explicitly enabled through OSCEN (Register 4-7).

4.3.2.7 HFOR and MFOR Bits

The HFOR and MFOR bits indicate that the HFINTOSC and MFINTOSC is ready. These clocks are always valid for use at all times, but only accurate after they are ready.

When a new value is loaded into the OSCFRQ register, the HFOR and MFOR bits will clear, and set again when the oscillator is ready. During pending OSCFRQ changes the MFINTOSC clock will stall at a high or a low state, until the HFINTOSC resumes operation.

4.4 Clock Switching

The system clock source can be switched between external and internal clock sources via software using the New Oscillator Source (NOSC) bits of the OSCCON1 register. The following clock sources can be selected using the following:

- External oscillator
- Internal Oscillator Block (INTOSC)

Note:	The Clock Switch Enable bit in Configuration Word 1 can be used to enable or disable the clock switching capability. When cleared, the NOSC and NDIV bits cannot be changed by user software. When set, writing to NOSC and NDIV is allowed and would switch the clock frequency.

4.4.1 NEW OSCILLATOR SOURCE (NOSC) AND NEW DIVIDER SELECTION REQUEST (NDIV) BITS

The New Oscillator Source (NOSC) and New Divider Selection Request (NDIV) bits of the OSCCON1 register select the system clock source and frequency that are used for the CPU and peripherals.

When new values of NOSC and NDIV are written to OSCCON1, the current oscillator selection will continue to operate while waiting for the new clock source to indicate that it is stable and ready. In some cases, the newly requested source may already be in use, and is ready immediately. In the case of a divider-only change, the new and old sources are the same, so the old source will be ready immediately. The device may enter Sleep while waiting for the switch as described in **Section 4.4.2 "Clock Switch and Sleep"**.

When the new oscillator is ready, the New Oscillator Ready (NOSCR) bit of OSCCON3 is set and also the Clock Switch Interrupt Flag (CSWIF) bit of PIR1 sets. If Clock Switch Interrupts are enabled (CSWIE = 1), an interrupt will be generated at that time. The Oscillator Ready (ORDY) bit of OSCCON3 can also be polled to determine when the oscillator is ready in lieu of an interrupt.

Note:	The CSWIF interrupt will not wake the system from Sleep.

If the Clock Switch Hold (CSWHOLD) bit of OSCCON3 is clear, the oscillator switch will occur when the New Oscillator is Ready bit (NOSCR) is set, and the interrupt (if enabled) will be serviced at the new oscillator setting.

If CSWHOLD is set, the oscillator switch is suspended, while execution continues using the current (old) clock source. When the NOSCR bit is set, software should:

- Set CSWHOLD = 0 so the switch can complete, or
- Copy COSC into NOSC to abandon the switch.

If DOZE is in effect, the switch occurs on the next clock cycle, whether or not the CPU is operating during that cycle.

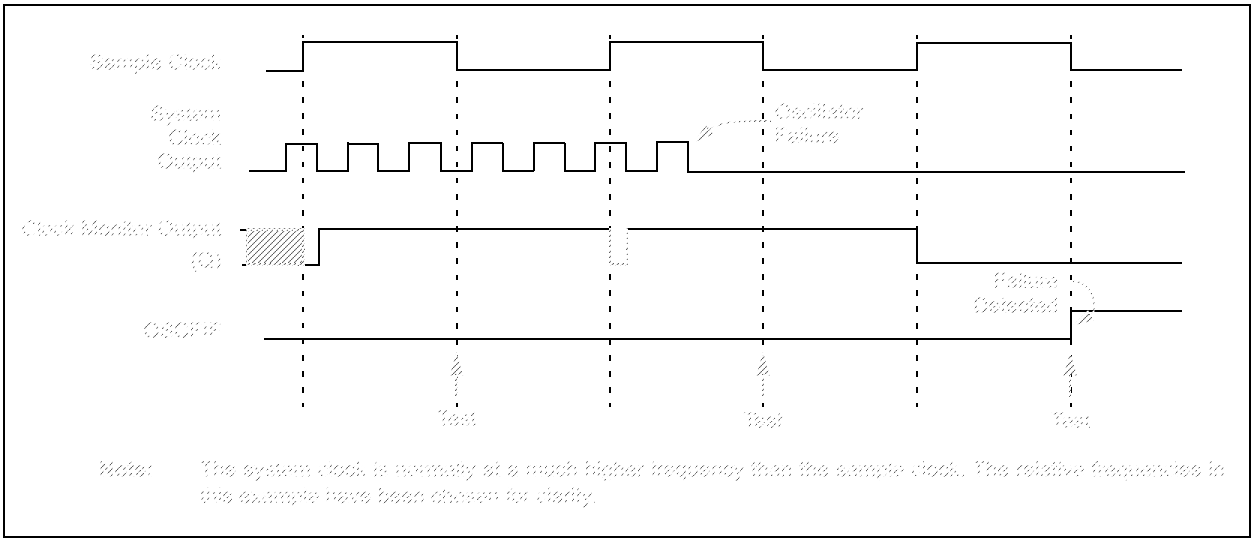
Changing the clock post-divider without changing the clock source (i.e., changing FOSC from 1 MHz to 2 MHz) is handled in the same manner as a clock source change, as described previously. The clock source will already be active, so the switch is relatively quick. CSWHOLD must be clear (CSWHOLD = 0) for the switch to complete.

The current COSC and CDIV are indicated in the OSCCON2 register up to the moment when the switch actually occurs, at which time OSCCON2 is updated and ORDY is set. NOSCR is cleared by hardware to indicate that the switch is complete.

4.5.4 RESET OR WAKE-UP FROM SLEEP

The FSCM is designed to detect an oscillator failure after the Oscillator Start-up Timer (OST) has expired. The OST is used after waking up from Sleep and after any type of Reset. The OST is not used with the EC Clock modes so that the FSCM will be active as soon as the Reset or wake-up has completed.

FIGURE 4-10: FSCM TIMING DIAGRAM



Note: The system clock is normally at a much higher frequency than the sample clock. The relative frequencies in this example have been chosen for clarity.

REGISTER 6-2: CPUDOZE: DOZE AND IDLE REGISTER

R/W-0/u	R/W/HC/HS-0/0	R/W-0/0	R/W-0/0	U-0	R/W-0/0	R/W-0/0	R/W-0/0
IDLEN	DOZEN	ROI	DOE	—	DOZE<2:0>		
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	HC = Bit is cleared by hardware

bit 7 **IDLEN:** Idle Enable bit
1 = A SLEEP instruction inhibits the CPU clock, but not the peripheral clock(s)
0 = A SLEEP instruction places the device into full Sleep mode

bit 6 **DOZEN:** Doze Enable bit(1,2)
1 = The CPU executes instruction cycles according to DOZE setting
0 = The CPU executes all instruction cycles (fastest, highest power operation)

bit 5 **ROI:** Recover-On-Interrupt bit
1 = Entering the Interrupt Service Routine (ISR) makes DOZEN = 0 bit, bringing the CPU to full-speed operation
0 = Interrupt entry does not change DOZEN

bit 4 **DOE:** Doze-On-Exit bit
1 = Executing RETFIE makes DOZEN = 1, bringing the CPU to reduced speed operation
0 = RETFIE does not change DOZEN

bit 3 **Unimplemented:** Read as ‘0’

bit 2-0 **DOZE<2:0>:** Ratio of CPU Instruction Cycles to Peripheral Instruction Cycles
111 =1:256
110 =1:128
101 =1:64
100 =1:32
011 =1:16
010 =1:8
001 =1:4
000 =1:2

Note 1: When ROI = 1 or DOE = 1, DOZEN is changed by hardware interrupt entry and/or exit.
2: Entering ICD overrides DOZEN, returning the CPU to full execution speed; this bit is not affected.

7.5 Register Definitions: Peripheral Module Disable

REGISTER 7-1: PMD0: PMD CONTROL REGISTER 0

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
SYSCMD	FVRMD	HLVDMD	CRCMD	SCANMD	NVMMD	CLKRMD	IOCMD
7							0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	q = Value depends on condition

bit 7 **SYSCMD:** Disable Peripheral System Clock Network bit(1)
See description in **Section 7.4 "System Clock Disable"**.
1 = System clock network disabled (FOSC)
0 = System clock network enabled

bit 6 **FVRMD:** Disable Fixed Voltage Reference bit
1 = FVR module disabled
0 = FVR module enabled

bit 5 **HLVDMD:** Disable Low-Voltage Detect bit
1 = HLVD module disabled
0 = HLVD module enabled

bit 4 **CRCMD:** Disable CRC Engine bit
1 = CRC module disabled
0 = CRC module enabled

bit 3 **SCANMD:** Disable NVM Memory Scanner bit(2)
1 = NVM Memory Scan module disabled
0 = NVM Memory Scan module enabled

bit 2 **NVMMD:** NVM Module Disable bit(3)
1 = All Memory reading and writing is disabled; NVMCON registers cannot be written
0 = NVM module enabled

bit 1 **CLKRMD:** Disable Clock Reference bit
1 = CLKR module disabled
0 = CLKR module enabled

bit 0 **IOCMD:** Disable Interrupt-on-Change bit, All Ports
1 = IOC module(s) disabled
0 = IOC module(s) enabled

Note 1: Clearing the SYSCMD bit disables the system clock (FOSC) to peripherals, however peripherals clocked by FOSC/4 are not affected.
2: Subject to SCANE bit in CONFIG4H.
3: When enabling NVM, a delay of up to 1 µs may be required before accessing data.

8.3 Power-on Reset (POR)

The POR circuit holds the device in Reset until VDD has reached an acceptable level for minimum operation. Slow rising VDD, fast operating speeds or analog performance may require greater than minimum VDD. The PWRT, BOR or MCLR features can be used to extend the start-up period until all device operation conditions have been met.

8.4 Brown-out Reset (BOR)

The BOR circuit holds the device in Reset when VDD reaches a selectable minimum level. Between the POR and BOR, complete voltage range coverage for execution protection can be implemented.

The Brown-out Reset module has four operating modes controlled by the BOREN<1:0> bits in Configuration Words. The four operating modes are:

- BOR is always on
- BOR is off when in Sleep
- BOR is controlled by software
- BOR is always off

Refer to Table 8-1 for more information.

The Brown-out Reset voltage level is selectable by configuring the BORV<1:0> bits in Configuration Words.

A VDD noise rejection filter prevents the BOR from triggering on small events. If VDD falls below VBOR for a duration greater than parameter TBORDC, the device will reset. See Table 37-11 for more information.

8.4.1 BOR IS ALWAYS ON

When the BOREN bits of Configuration Words are programmed to '11', the BOR is always on. The device start-up will be delayed until the BOR is ready and VDD is higher than the BOR threshold.

BOR protection is active during Sleep. The BOR does not delay wake-up from Sleep.

8.4.2 BOR IS OFF IN SLEEP

When the BOREN bits of Configuration Words are programmed to '10', the BOR is on, except in Sleep. The device start-up will be delayed until the BOR is ready and VDD is higher than the BOR threshold.

BOR protection is not active during Sleep. The device wake-up will be delayed until the BOR is ready.

8.4.3 BOR CONTROLLED BY SOFTWARE

When the BOREN bits of Configuration Words are programmed to '01', the BOR is controlled by the SBOREN bit of the BORCON register. The device start-up is not delayed by the BOR ready condition or the VDD level.

BOR protection begins as soon as the BOR circuit is ready. The status of the BOR circuit is reflected in the BORRDY bit of the BORCON register.

BOR protection is unchanged by Sleep.

8.4.4 BOR AND BULK ERASE

BOR is forced ON during PFM Bulk Erase operations to make sure that the system code protection cannot be compromised by reducing VDD.

During Bulk Erase, the BOR is enabled at 2.45V for F and LF devices, even if it is configured to some other value. If VDD falls, the erase cycle will be aborted, but the device will not be reset.

REGISTER 11-2: NVMCON2: NONVOLATILE MEMORY CONTROL 2 REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
NVMCON2<7:0>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
x = Bit is unknown	'0' = Bit is cleared	'1' = Bit is set
-n = Value at POR		

bit 7-0 **NVMCON2<7:0>:**
Refer to **Section 11.1.4 "NVM Unlock Sequence"**.

Note 1: This register always reads zeros, regardless of data written.

Register 11-3: NVMADRL: Data EEPROM Memory Address Low

R/W-x/0	R/W-x/0	R/W-x/0	R/W-x/0	R/W-x/0	R/W-x/0	R/W-x/0	R/W-x/0
NVMADR<7:0>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
x = Bit is unknown	'0' = Bit is cleared	'1' = Bit is set
-n = Value at POR		

bit 7-0 **NVMADR<7:0>:** EEPROM Read Address bits

REGISTER 11-4: NVMADRH: DATA EEPROM MEMORY ADDRESS HIGH(1)

U-0	U-0	U-0	U-0	U-0	U-0	R/W-x/u	R/W-x/u
—	—	—	—	—	—	NVMADR<9:8>	
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
x = Bit is unknown	'0' = Bit is cleared	'1' = Bit is set
-n = Value at POR		

bit 7-2 **Unimplemented:** Read as '0'
bit 1-0 **NVMADR<9:8>:** EEPROM Read Address bits

Note 1: The NVMADRH register is not implemented on PIC18(L)F24/25K40.

REGISTER 14-4: PIR2: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 2

R/W-0/0	R/W-0/0	U-0	U-0	U-0	U-0	R/W-0/0	R/W-0/0
HLVDIF	ZCDIF	—	—	—	—	C2IF	C1IF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7 **HLVDIF:** HLVD Interrupt Flag bit
1 = HLVD interrupt event has occurred
0 = HLVD interrupt event has not occurred or has not been set up

bit 6 **ZCDIF:** Zero-Cross Detect Interrupt Flag bit
1 = ZCD Output has changed (must be cleared in software)
0 = ZCD Output has not changed

bit 5-2 **Unimplemented:** Read as ‘0’

bit 1 **C2IF:** Comparator 2 Interrupt Flag bit
1 = Comparator C2 output has changed (must be cleared by software)
0 = Comparator C2 output has not changed

bit 0 **C1IF:** Comparator 1 Interrupt Flag bit
1 = Comparator C1 output has changed (must be cleared by software)
0 = Comparator C1 output has not changed

REGISTER 14-8: PIR6: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 6

U-0	U-0	U-0	U-0	U-0	U-0	R/W-0/0	R/W-0/0
—	—	—	—	—	—	CCP2IF	CCP1IF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-2 **Unimplemented:** Read as '0'

bit 1 **CCP2IF:** ECCP2 Interrupt Flag bit

Capture mode:

1 = A TMR register capture occurred (must be cleared in software)

0 = No TMR register capture occurred

Compare mode:

1 = A TMR register compare match occurred (must be cleared in software)

0 = No TMR register compare match occurred

PWM mode:

Unused in PWM mode.

bit 0 **CCP1IF:** ECCP1 Interrupt Flag bit

Capture mode:

1 = A TMR register capture occurred (must be cleared in software)

0 = No TMR register capture occurred

Compare mode:

1 = A TMR register compare match occurred (must be cleared in software)

0 = No TMR register compare match occurred

PWM mode:

Unused in PWM mode.

REGISTER 15-7: SLRCONx: SLEW RATE CONTROL REGISTER

R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1
SLRx7	SLRx6	SLRx5	SLRx4	SLRx3	SLRx2	SLRx1	SLRx0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown
-n/n = Value at POR and BOR/Value at all other Resets		

bit 7-0 **SLRx<7:0>**: Slew Rate Control on Pins Rx<7:0>, respectively

1 = Port pin slew rate is limited

0 = Port pin slews at maximum rate

TABLE 15-8: SLEW RATE CONTROL REGISTERS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
SLRCONA	SLRA7	SLRA6	SLRA5	SLRA4	SLRA3	SLRA2	SLRA1	SLRA0
SLRCONB	SLRB7	SLRB6	SLRB5	SLRB4	SLRB3	SLRB2	SLRB1	SLRB0
SLRCONC	SLRC7	SLRC6	SLRC5	SLRC4	SLRC3	SLRC2	SLRC1	SLRC0

REGISTER 15-8: INLVLx: INPUT LEVEL CONTROL REGISTER

R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1
INLVLx7	INLVLx6	INLVLx5	INLVLx4	INLVLx3	INLVLx2	INLVLx1	INLVLx0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown
-n/n = Value at POR and BOR/Value at all other Resets		

bit 7-0 **INLVLx<7:0>**: Input Level Select on Pins Rx<7:0>, respectively
1 = ST input used for port reads and interrupt-on-change
0 = TTL input used for port reads and interrupt-on-change

TABLE 15-9: INPUT LEVEL PORT REGISTERS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
INLVLA	INLVLA7	INLVLA6	INLVLA5	INLVLA4	INLVLA3	INLVLA2	INLVLA1	INLVLA0
INLVLB	INLVLB7	INLVLB6	INLVLB5	INLVLB4	INLVLB3	INLVLB2(1)	INLVLB1(1)	INLVLB0
INLVLC	INLVLC7	INLVLC6	INLVLC5	INLVLC4(1)	INLVLC3(1)	INLVLC2	INLVLC1	INLVLC0
INLVLE	—	—	—	—	INLVLE3	—	—	—

Note 1: Pins read the I^2C ST inputs when MSSP inputs select these pins, and I^2C mode is enabled.

TABLE 21-3: EXAMPLE PWM FREQUENCIES AND RESOLUTIONS (FOSC = 20 MHz)

PWM Frequency	1.22 kHz	4.88 kHz	19.53 kHz	78.12 kHz	156.3 kHz	208.3 kHz
Timer Prescale	16	4	1	1	1	1
PR2 Value	0xFF	0xFF	0xFF	0x3F	0x1F	0x17
Maximum Resolution (bits)	10	10	10	8	7	6.6

TABLE 21-4: EXAMPLE PWM FREQUENCIES AND RESOLUTIONS (FOSC = 8 MHz)

PWM Frequency	1.22 kHz	4.90 kHz	19.61 kHz	76.92 kHz	153.85 kHz	200.0 kHz
Timer Prescale	16	4	1	1	1	1
PR2 Value	0x65	0x65	0x65	0x19	0x0C	0x09
Maximum Resolution (bits)	8	8	8	6	5	5

21.5.7 OPERATION IN SLEEP MODE

In Sleep mode, the TMR2 register will not increment and the state of the module will not change. If the CCPx pin is driving a value, it will continue to drive that value. When the device wakes up, TMR2 will continue from its previous state.

21.5.8 CHANGES IN SYSTEM CLOCK FREQUENCY

The PWM frequency is derived from the system clock frequency. Any changes in the system clock frequency will result in changes to the PWM frequency. See **Section 4.0 "Oscillator Module (with Fail-Safe Clock Monitor)"** for additional details.

21.5.9 EFFECTS OF RESET

Any Reset will force all ports to Input mode and the CCP registers to their Reset states.

24.7 Rising Edge and Reverse Dead Band

In Half-Bridge mode, the rising edge dead band delays the turn-on of the CWG1A output after the rising edge of the CWG data input. In Full-Bridge mode, the reverse dead-band delay is only inserted when changing directions from Forward mode to Reverse mode, and only the modulated output CWG1B is affected.

The CWG1DBR register determines the duration of the dead-band interval on the rising edge of the input source signal. This duration is from 0 to 64 periods of the CWG clock.

Dead band is always initiated on the edge of the input source signal. A count of zero indicates that no dead band is present.

If the input source signal reverses polarity before the dead-band count is completed, then no signal will be seen on the respective output.

The CWG1DBR register value is double-buffered. When EN = 0 (Register 24-1), the buffer is loaded when CWG1DBR is written. If EN = 1, then the buffer will be loaded at the rising edge following the first falling edge of the data input, after the LD bit (Register 24-1) is set. Refer to Figure 24-12 for an example.

24.8 Falling Edge and Forward Dead Band

In Half-Bridge mode, the falling edge dead band delays the turn-on of the CWG1B output at the falling edge of the CWG data input. In Full-Bridge mode, the forward dead-band delay is only inserted when changing directions from Reverse mode to Forward mode, and only the modulated output CWG1D is affected.

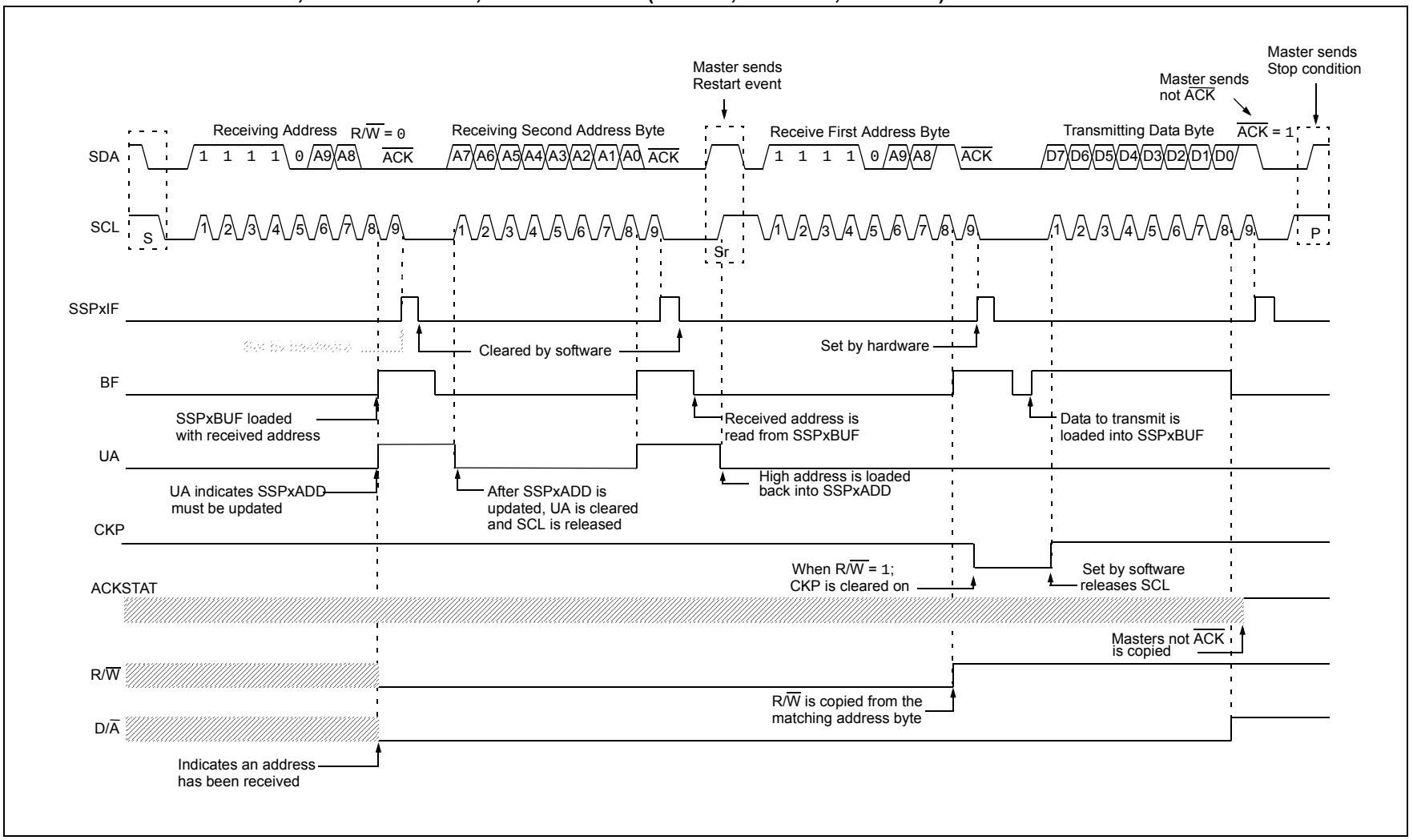
The CWG1DBF register determines the duration of the dead-band interval on the falling edge of the input source signal. This duration is from zero to 64 periods of CWG clock.

Dead-band delay is always initiated on the edge of the input source signal. A count of zero indicates that no dead band is present.

If the input source signal reverses polarity before the dead-band count is completed, then no signal will be seen on the respective output.

The CWG1DBF register value is double-buffered. When EN = 0 (Register 24-1), the buffer is loaded when CWG1DBF is written. If EN = 1, then the buffer will be loaded at the rising edge following the first falling edge of the data input after the LD (Register 24-1) is set. Refer to Figure 24-13 for an example.

FIGURE 26-22: I²C SLAVE, 10-BIT ADDRESS, TRANSMISSION (SEN = 0, AHEN = 0, DHEN = 0)



28.3 Register Definitions: FVR Control

REGISTER 28-1: FVRCON: FIXED VOLTAGE REFERENCE CONTROL REGISTER

R/W-0/0	R-q/q	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
FVREN	FVRRDY(1)	TSEN(3)	TSRNG(3)	CDAFVR<1:0>		ADFVR<1:0>	
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	q = Value depends on condition

bit 7 **FVREN:** Fixed Voltage Reference Enable bit
1 = Fixed Voltage Reference is enabled
0 = Fixed Voltage Reference is disabled

bit 6 **FVRRDY:** Fixed Voltage Reference Ready Flag bit(1)
1 = Fixed Voltage Reference output is ready for use
0 = Fixed Voltage Reference output is not ready or not enabled

bit 5 **TSEN:** Temperature Indicator Enable bit(3)
1 = Temperature Indicator is enabled
0 = Temperature Indicator is disabled

bit 4 **TSRNG:** Temperature Indicator Range Selection bit(3)
1 = VOUT = VDD - 4VT (High Range)
0 = VOUT = VDD - 2VT (Low Range)

bit 3-2 **CDAFVR<1:0>:** Comparator FVR Buffer Gain Selection bits
11 = Comparator FVR Buffer Gain is 4x, (4.096V)(2)
10 = Comparator FVR Buffer Gain is 2x, (2.048V)(2)
01 = Comparator FVR Buffer Gain is 1x, (1.024V)
00 = Comparator FVR Buffer is off

bit 1-0 **ADFVR<1:0>:** ADC FVR Buffer Gain Selection bit
11 = ADC FVR Buffer Gain is 4x, (4.096V)(2)
10 = ADC FVR Buffer Gain is 2x, (2.048V)(2)
01 = ADC FVR Buffer Gain is 1x, (1.024V)
00 = ADC FVR Buffer is off

Note 1: FVRRDY is always '1'.
2: Fixed Voltage Reference output cannot exceed VDD.
3: See **Section 29.0 "Temperature Indicator Module"** for additional information.

TABLE 28-1: SUMMARY OF REGISTERS ASSOCIATED WITH FIXED VOLTAGE REFERENCE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on page
FVRCON	FVREN	FVRRDY	TSEN	TSRNG	CDAFVR<1:0>		ADFVR<1:0>		417
ADCON0	ADON	ADCONT	—	ADCS	—	ADFM	—	ADGO	441
CMxNCH	—	—	—	—	—	CxNCH<2:0>			463
CMxPCH	—	—	—	—	—	CxPCH<2:0>			464
DAC1CON1	—	—	—	DAC1R<4:0>					423

Legend: — = Unimplemented location, read as '0'. Shaded cells are not used with the Fixed Voltage Reference.

REGISTER 31-3: ADCON2: ADC CONTROL REGISTER 2

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W/HC-0	R/W-0/0	R/W-0/0	R/W-0/0
ADPSIS	ADCRS<2:0>			ADACLR	ADMD<2:0>		
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HC = Bit is cleared by hardware

bit 7 **ADPSIS:** ADC Previous Sample Input Select bits
1 = ADFLTR is transfered to ADPREV at start-of-conversion
0 = ADRES is transfered to ADPREV at start-of-conversion

bit 6-4 **ADCRS<2:0>:** ADC Accumulated Calculation Right Shift Select bits
If ADMD = 100:
Low-pass filter time constant is 2^{ADCRS}, filter gain is 1:1
If ADMD = 001, 010 or 011:
The accumulated value is right-shifted by ADCRS (divided by 2^{ADCRS})**(1,2)**
Otherwise:
Bits are ignored

bit 3 **ADACLR:** A/D Accumulator Clear Command bit**(3)**
0 = Clearing action is complete (or not started)
1 = ADACC, ADAOV and ADCNT registers are cleared

bit 2-0 **ADMD<2:0>:** ADC Operating Mode Selection bits**(4)**
111-101 = Reserved
100 = Low-pass Filter mode
011 = Burst Average mode
010 = Average mode
001 = Accumulate mode
000 = Basic (Legacy) mode

Note 1: To correctly calculate an average, the number of samples (set in ADRPT) must be 2ADCRS.
2: ADCRS = 3'b111 is a reserved option.
3: This bit is cleared by hardware when the accumulator operation is complete; depending on oscillator selections, the delay may be many instructions.
4: See Table 31-2 for Full mode descriptions.

REGISTER 32-4: CMxPCH: COMPARATOR x NON-INVERTING CHANNEL SELECT REGISTER

U-0	U-0	U-0	U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0
—	—	—	—	—	PCH<2:0>		
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-3 **Unimplemented:** Read as '0'

bit 2-0 **PCH<2:0>:** Comparator Non-Inverting Input Channel Select bits

111 = AVSS
110 = FVR_Buffer2
101 = DAC_Output
100 = CxPCH not connected
011 = CxPCH not connected
010 = CxPCH not connected
001 = CxIN1+
000 = CxIN0+

REGISTER 32-5: CMOUT: COMPARATOR OUTPUT REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	R-0/0	R-0/0
—	—	—	—	—	—	MC2OUT	MC1OUT
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-2 **Unimplemented:** Read as '0'

bit 1 **MC2OUT:** Mirror copy of C2OUT bit

bit 0 **MC1OUT:** Mirror copy of C1OUT bit

32.9 Comparator Response Time

The comparator output is indeterminate for a period of time after the change of an input source or the selection of a new reference voltage. This period is referred to as the response time. The response time of the comparator differs from the settling time of the voltage reference. Therefore, both of these times must be considered when determining the total response time to a comparator input change. See the Comparator and Voltage Reference Specifications in Table 37-15 and Table 37-17 for more details.

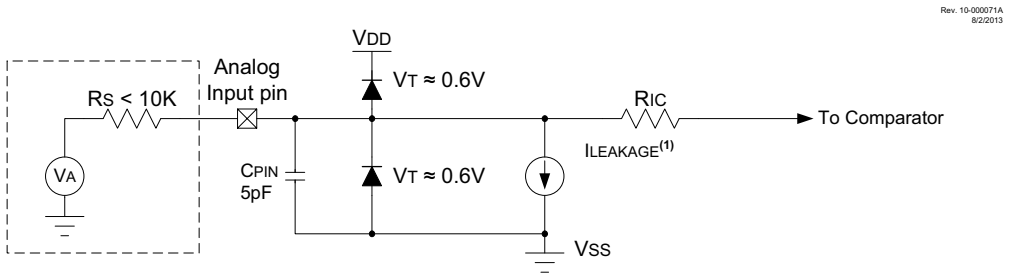
32.10 Analog Input Connection Considerations

A simplified circuit for an analog input is shown in Figure 32-3. Since the analog input pins share their connection with a digital input, they have reverse biased ESD protection diodes to V_{DD} and V_{SS}. The analog input, therefore, must be between V_{SS} and V_{DD}. If the input voltage deviates from this range by more than 0.6V in either direction, one of the diodes is forward biased and a latch-up may occur.

A maximum source impedance of 10 kΩ is recommended for the analog sources. Also, any external component connected to an analog input pin, such as a capacitor or a Zener diode, should have very little leakage current to minimize inaccuracies introduced.

Note 1:	When reading a PORT register, all pins configured as analog inputs will read as a '0'. Pins configured as digital inputs will convert as an analog input, according to the input specification.
2:	Analog levels on any pin defined as a digital input, may cause the input buffer to consume more current than is specified.

FIGURE 32-3: ANALOG INPUT MODEL



Legend: C_{PIN} = Input Capacitance
$I_{LEAKAGE}$ = Leakage Current at the pin due to various junctions
R_{IC} = Interconnect Resistance
R_S = Source Impedance
V_A = Analog Voltage
V_T = Threshold Voltage

Note 1: See **Section 37.0 "Electrical Specifications"**.

TABLE 37-4: I/O PORTS

Standard Operating Conditions (unless otherwise stated)							
Param No.	**Sym.**	**Characteristic**	**Min.**	**Typ†**	**Max.**	**Units**	**Conditions**
	VIL	**Input Low Voltage**					
		I/O PORT:					
D300		with TTL buffer	—	—	0.8	V	4.5V ≤ VDD ≤ 5.5V
D301			—	—	0.15 VDD	V	1.8V ≤ VDD ≤ 4.5V
D302		with Schmitt Trigger buffer	—	—	0.2 VDD	V	2.0V ≤ VDD ≤ 5.5V
D303		with I^2C levels	—	—	0.3 VDD	V	
D304		with SMBus levels	—	—	0.8	V	2.7V ≤ VDD ≤ 5.5V
D305		$\overline{MCLR}$	—	—	0.2 VDD	V	
	VIH	**Input High Voltage**					
		I/O PORT:					
D320		with TTL buffer	2.0	—	—	V	4.5V ≤ VDD ≤ 5.5V
D321			0.25 VDD + 0.8	—	—	V	1.8V ≤ VDD ≤ 4.5V
D322		with Schmitt Trigger buffer	0.8 VDD	—	—	V	2.0V ≤ VDD ≤ 5.5V
D323		with I^2C levels	0.7 VDD	—	—	V	
D324		with SMBus levels	2.1	—	—	V	2.7V ≤ VDD ≤ 5.5V
D325		$\overline{MCLR}$	0.7 VDD	—	—	V	
	IIL	**Input Leakage Current(1)**					
D340		I/O Ports	—	± 5	± 125	nA	VSS ≤ VPIN ≤ VDD, Pin at high-impedance, 85°C
D341			—	± 5	± 1000	nA	VSS ≤ VPIN ≤ VDD, Pin at high-impedance, 125°C
D342		$\overline{MCLR}$(2)	—	± 50	± 200	nA	VSS ≤ VPIN ≤ VDD, Pin at high-impedance, 85°C
	IPUR	**Weak Pull-up Current**					
D350			25	120	200	µA	VDD = 3.0V, VPIN = VSS
	VOL	**Output Low Voltage**					
D360		I/O ports	—	—	0.6	V	IOL = 10.0mA, VDD = 3.0V
	VOH	**Output High Voltage**					
D370		I/O ports	VDD - 0.7	—	—	V	IOH = 6.0 mA, VDD = 3.0V
D380	CIO	**All I/O pins**	—	5	50	pF	

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Negative current is defined as current sourced by the pin.

2: The leakage current on the $\overline{MCLR}$ pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

TABLE 37-14: ANALOG-TO-DIGITAL CONVERTER (ADC) CONVERSION TIMING SPECIFICATIONS

Standard Operating Conditions (unless otherwise stated)							
Param No.	**Sym.**	**Characteristic**	**Min.**	**Typ†**	**Max.**	**Units**	**Conditions**
AD20	TAD	ADC Clock Period	1	—	9	µs	Using FOSC as the ADC clock source ADOCS = 0
AD21			—	2	—	µs	Using FRC as the ADC clock source ADOCS = 1
AD22	TCNV	Conversion Time(1)	—	11 + 3TCY	—	TAD	Set of GO/$\overline{\text{DONE}}$ bit to Clear of GO/$\overline{\text{DONE}}$ bit
AD23	TACQ	Acquisition Time	—	2	—	µs	
AD24	THCD	Sample and Hold Capacitor Disconnect Time	—	—	—	µs	FOSC-based clock source FRC-based clock source

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Does not apply for the ADCRC oscillator.

FIGURE 37-10: ADC CONVERSION TIMING (ADC CLOCK FOSC-BASED)